

SENSITIVE GATE TRIACS

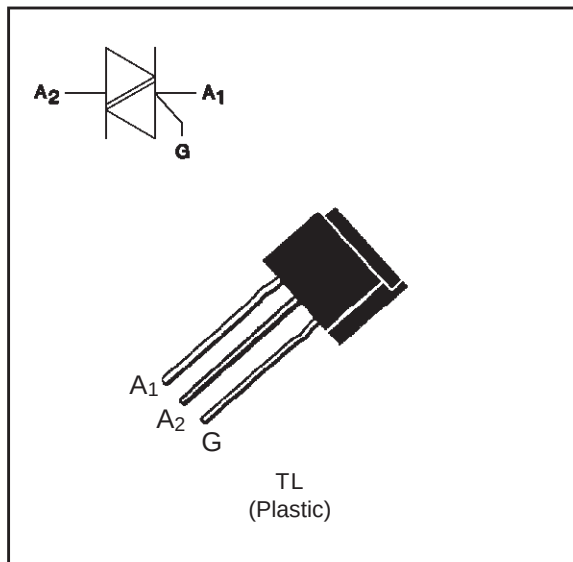
FEATURES

- VERY LOW $I_{GT} = 5\text{mA max}$
- LOW $I_H = 15\text{mA max}$

DESCRIPTION

The TLC116 ---> TLC386 T/D/S/A triac family uses a high performance glass passivated PNPN technology.

These parts are suitable for general purpose applications where gate high sensitivity is required. Application on 4Q such as phase control and static



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$I_T(\text{RMS})$	RMS on-state current (360° conduction angle)	$T_I = 40^\circ\text{C}$	3	A
		$T_a = 25^\circ\text{C}$	1.3 (1)	
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = 25°C)	$t_p = 8.3\text{ ms}$	31.5	A
		$t_p = 10\text{ ms}$	30	
i^2t	i^2t value	$t_p = 10\text{ ms}$	4.5	A^2s
di/dt	Critical rate of rise of on-state current Gate supply : $I_G = 50\text{mA}$ $di_G/dt = 0.1\text{A}/\mu\text{s}$	Repetitive $F = 50\text{ Hz}$	10	$\text{A}/\mu\text{s}$
		Non Repetitive	50	
T_{stg} T_j	Storage and operating junction temperature range		- 40 to + 150 - 40 to + 110	$^\circ\text{C}$ $^\circ\text{C}$
T_I	Maximum lead temperature for soldering during 4 s at 4.5 mm from case		230	$^\circ\text{C}$

Symbol	Parameter	TLC				Unit
		116 T/D/S/A	226 T/D/S/A	336 T/D/S/A	386 T/D/S/A	
V_{DRM} V_{RRM}	Repetitive peak off-state voltage $T_j = 110^\circ\text{C}$	200	400	600	700	V

(1) With Cu surface 1cm^2 .

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
Rth (j-a)	Junction to ambient on printed circuit with Cu surface 1cm ²	50	°C/W
Rth (j-l) DC	Junction leads for DC	20	°C/W
Rth (j-l) AC	Junction leads for 360° conduction angle (F= 50 Hz)	15	°C/W

GATE CHARACTERISTICS (maximum values)

P_G (AV) = 0.1W P_{GM} = 2W (tp = 20 μs) I_{GM} = 1A (tp = 20 μs) V_{GM} = 16V (tp = 20 μs).

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions		Quadrant		Suffix				Unit
					T	D	S	A	
I _{GT}	V _D =12V (DC) R _L =33Ω	T _j =25°C	I-II-III	MAX	5	5	10	10	mA
			IV	MAX	5	10	10	25	
V _{GT}	V _D =12V (DC) R _L =33Ω	T _j =25°C	I-II-III-IV	MAX	1.5				V
V _{GD}	V _D =V _{DRM} R _L =3.3kΩ	T _j =110°C	I-II-III-IV	MIN	0.2				V
tgt	V _D =V _{DRM} I _G = 40mA dI _G /dt = 0.5A/μs	T _j =25°C	I-II-III-IV	TYP	2				μs
I _L	I _G = 1.2 I _{GT}	T _j =25°C	I-III-IV	MAX	15	15	25	25	mA
			II		15	15	25	25	
I _H *	I _T = 100mA gate open	T _j =25°C		MAX	15	15	25	25	mA
V _{TM} *	I _{TM} = 4A tp= 380μs	T _j =25°C		MAX	1.85				V
I _{DRM} I _{RRM}	V _{DRM} Rated V _{RRM} Rated	T _j =25°C		MAX	0.01				mA
		T _j =110°C		MAX	0.75				
dV/dt *	Linear slope up to V _D =67%V _{DRM} gate open	T _j =110°C		TYP	10	10	20	20	V/μs
(dV/dt) _c *	(dI/dt) _c = 1.3A/ms	T _j =110°C		TYP	1	1	5	5	V/μs

* For either polarity of electrode A₂ voltage with reference to electrode A₁.

ORDERING INFORMATION

Package	$I_T(\text{RMS})$	$V_{\text{DRM}} / V_{\text{RRM}}$	Sensitivity Specification			
	A	V	T	D	S	A
TLC ..6	3	200	X	X	X	X
		400	X	X	X	X
		600	X	X	X	X
		700	X	X	X	X

Fig.1 : Maximum RMS power dissipation versus RMS on-state current ($F=50\text{Hz}$).
(Curves are cut off by $(di/dt)_c$ limitation)

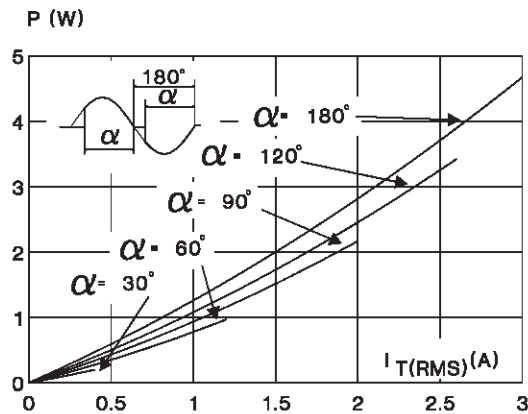


Fig.3 : RMS on-state current versus case temperature.

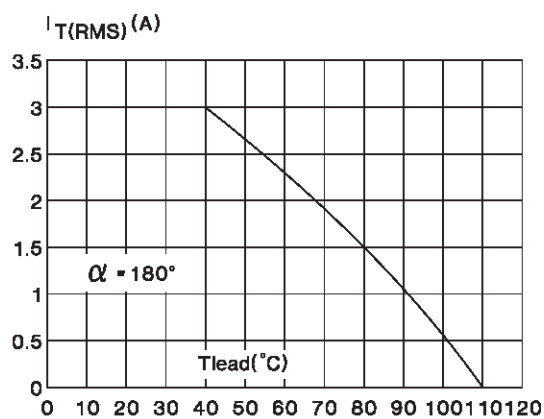


Fig.2 : Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{lead}).

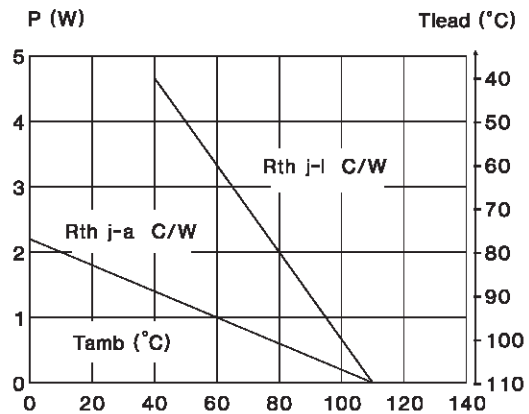
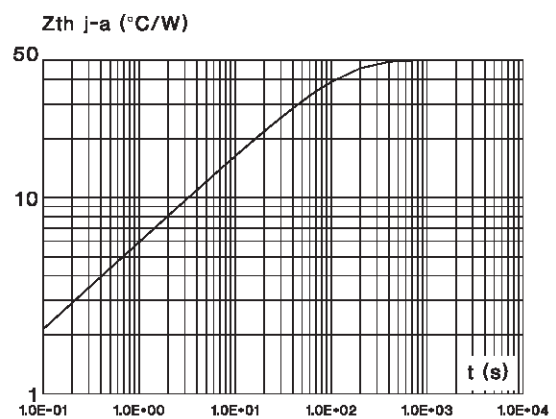


Fig.4 : Thermal transient impedance junction to case and junction to ambient versus pulse duration.



TLC116 T/D/S/A ---> TLC386 T/D/S/A

Fig.5 : Relative variation of gate trigger current and holding current versus junction temperature.

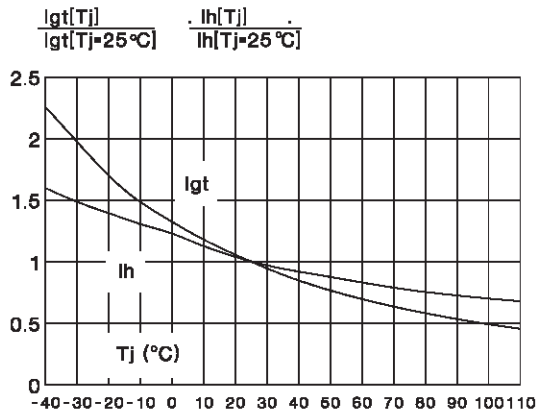


Fig.6 : Non Repetitive surge peak on-state current versus number of cycles.

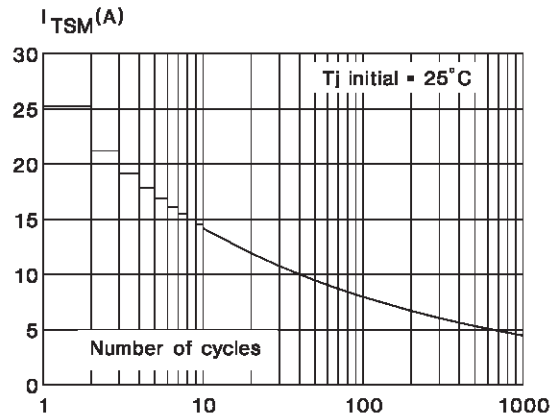


Fig.7 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10\text{ms}$, and corresponding value of I^2t .

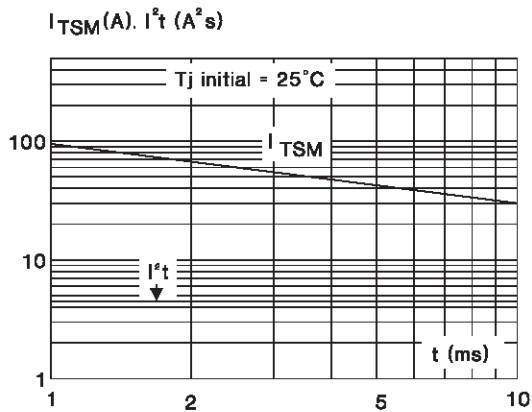
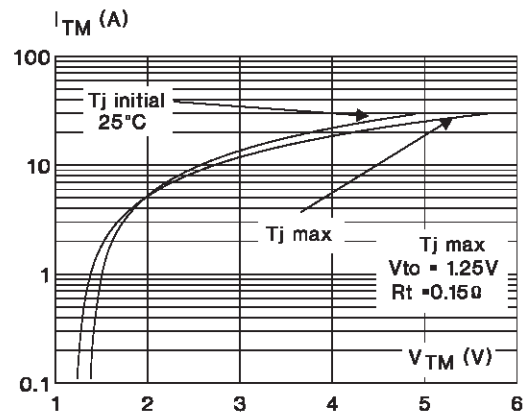
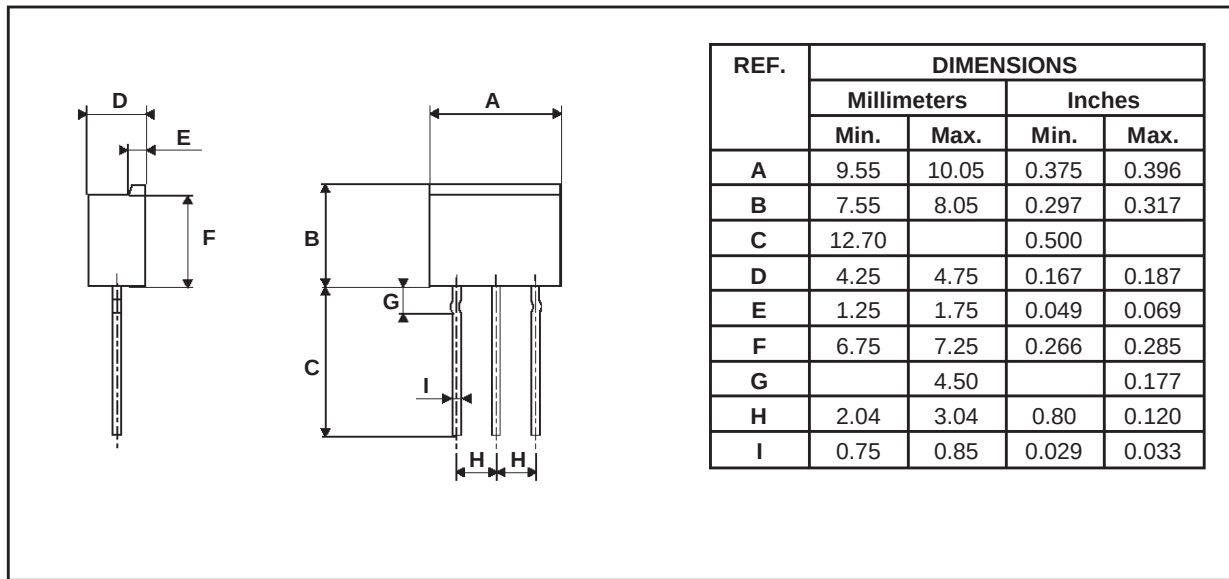


Fig.8 : On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA

TL Plastic



Marking : type number
Weight : 0.75 g

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